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SERIAL NUMBER 10/823,611	FILING DATE 04/14/2004  RULE	CLASS 029	GROUP ART UNIT 3729	ATTORNEY DOCKET NO. SOCKET 3.0-001 DIV I DIV
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## APPLICANTS

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Yes *MJ*

## \*\* CONTINUING DATA \*\*\*\*\*

This application is a DIV of 10/139,237 05/07/2002 PAT 6,828,221  
 which is a DIV of 09/685,799 10/11/2000 PAT 6,528,874

Yes *MJ*

## \*\* FOREIGN APPLICATIONS \*\*\*\*\*

JAPAN 11-289277 10/12/1999  
 JAPAN 11-374462 12/28/1999  
 JAPAN 2000-142658 05/16/2000

## IF REQUIRED, FOREIGN FILING LICENSE GRANTED \*\* SMALL ENTITY \*\*

\*\* 06/25/2004

Foreign Priority claimed 35 USC 119 (a-d) conditions met	STATE OR COUNTRY JAPAN	SHEETS DRAWING 53	TOTAL CLAIMS 6	INDEPENDENT CLAIMS 1
yes <input checked="" type="checkbox"/> no <input type="checkbox"/> <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after <i>Allowance</i> <i>Examiner's Signature</i> <i>Initials</i>				

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## TITLE

Manufacturing method for wiring circuit substrate

 All Fees